

Challenges for SoC Integration of Multistandard-RF-Circuits

Prof. Stefan Heinen

Fellow IEEE

Chair of Integrated Analog Circuits & RF Subsystems
RWTH Aachen



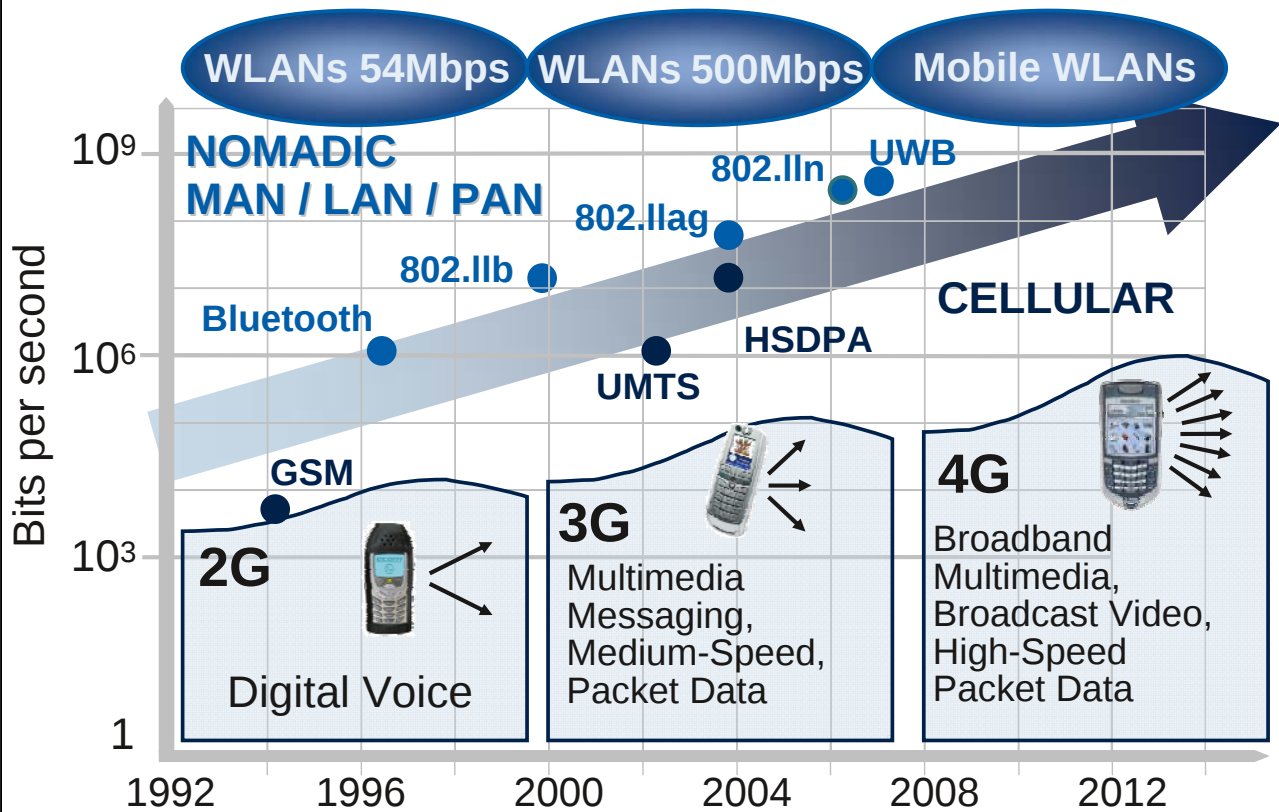
Never stop thinking

Outline



- **Introduction**
- Cellular RF SoC - State of the Art
- Multistandard RF Requirements
- Issues to solve
- Conclusions

The Wireless Evolution requires advanced RF-SoC Integration



25. Juni 2008

MPSoC 2008



Page 3

Requirements Multimode Terminals



Standard		Uplink		Downlink	
3GPP / GSM	T-GSM 380	380	- 390	390	- 400
3GPP / GSM	T-GSM 410	410	- 420	420	- 430
3GPP / GSM	GSM 450	450	- 460	460	- 470
3GPP / GSM	GSM 480	479	- 486	489	- 496
3GPP	US	728	- 746	698	- 716
3GPP / GSM	GSM 750	747	- 762	777	- 792
3GPP	US	777	- 792	747	- 762
3GPP / GSM	Band XVIII	824	- 849	869	- 894
3GPP	Band XIX	830	- 840	875	- 885
3GPP / GSM	Band XX	880	- 915	925	- 960
3GPP	JP	1428	- 1448	1476	- 1496
3GPP / GSM	Band XXII	1710	- 1785	1805	- 1880
3GPP	Band XXIII	1710	- 1755	2110	- 2155
3GPP	Band XXIV	1750	- 1785	1845	- 1880
3GPP / GSM	Band XXV	1850	- 1910	1930	- 1990
3GPP	Band I	1920	- 1980	2110	- 2170
WiMAX		2300	- 2400	2300	- 2400
WiFi	ISM 2400	2400	- 2483	2400	- 2483
Bluetooth	ISM 2400	2400	- 2483	2400	- 2483
WiMAX		2496	- 2690	2496	- 2690
3GPP	Band I	2500	- 2570	2620	- 2690
WiMAX		3300	- 3800	3300	- 3800
WiFi	ISM 5800	5725	- 5875	5725	- 5875

Recommended:

- At least 3 UMTS bands
- At least 4 GSM bands

Optional:

- WiFi 2.4 (5.8)
- WiMax 2.3, 2.5 (3.4)

Parallel Operation:

- GSM/UMTS same receiver
- WiFi / WiMAX same receiver
- BT / BT ULP same receiver

25. Juni 2008

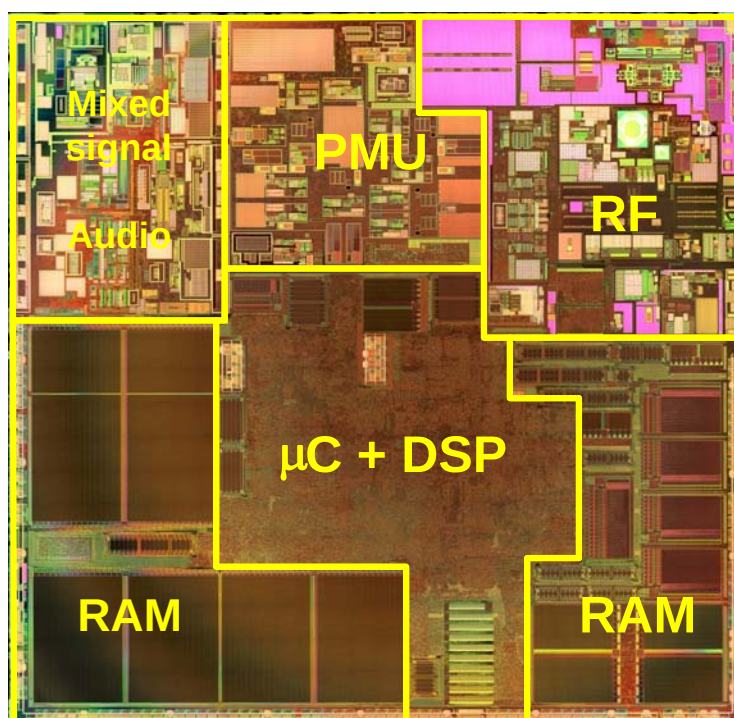
MPSoC 2008



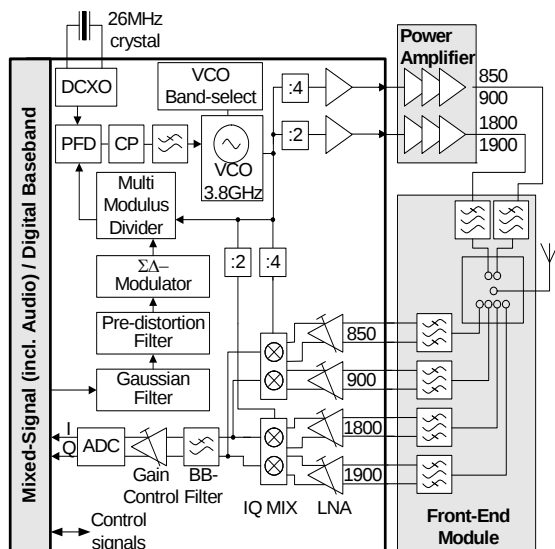
Page 4

- Introduction
- **Cellular RF SoC - State of the Art**
- Multistandard RF Requirements
- Issues to solve
- Conclusions

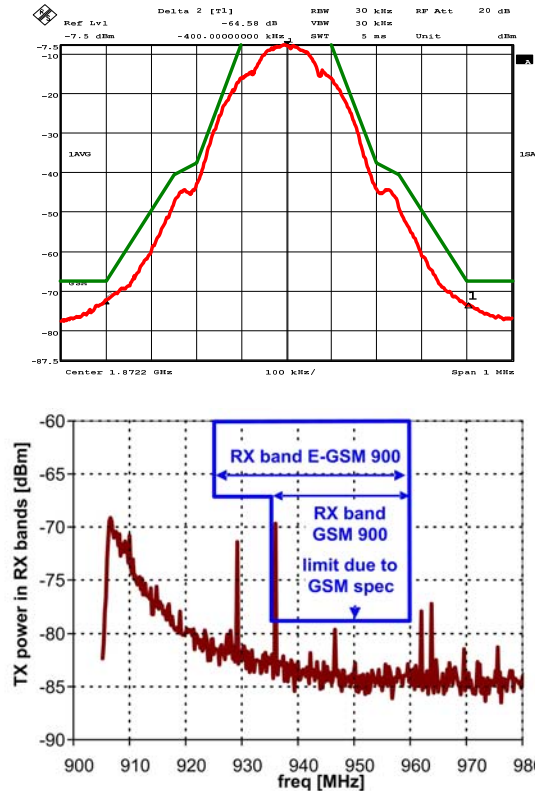
Infineon Ultra Low Cost Mobile



RF-SoC without Performance Loss



- Noise figure: 2.6dB
- Sensitivity: -113dBm



25. Juni 2008

MPSoC 2008

ge 7

Multi Standard RF SoCs in nanoscale CMOS



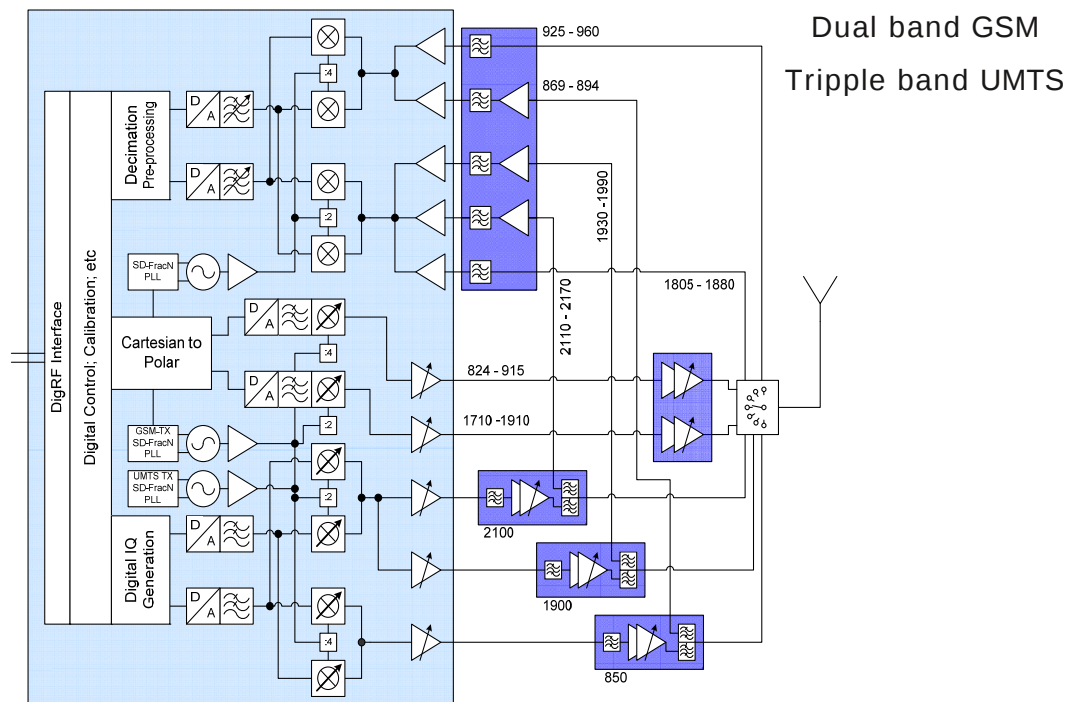
- RF-BB co-integration enabling high volume
- Only linear shrink for RF and analog
- One CMOS technology for RF and Digital
- 65nm CMOS is state of the art today

Solution for nanoscale CMOS:

- **Increase Digital Signal Processing**
- **Avoid Analog Processing**

25. Juni 2008

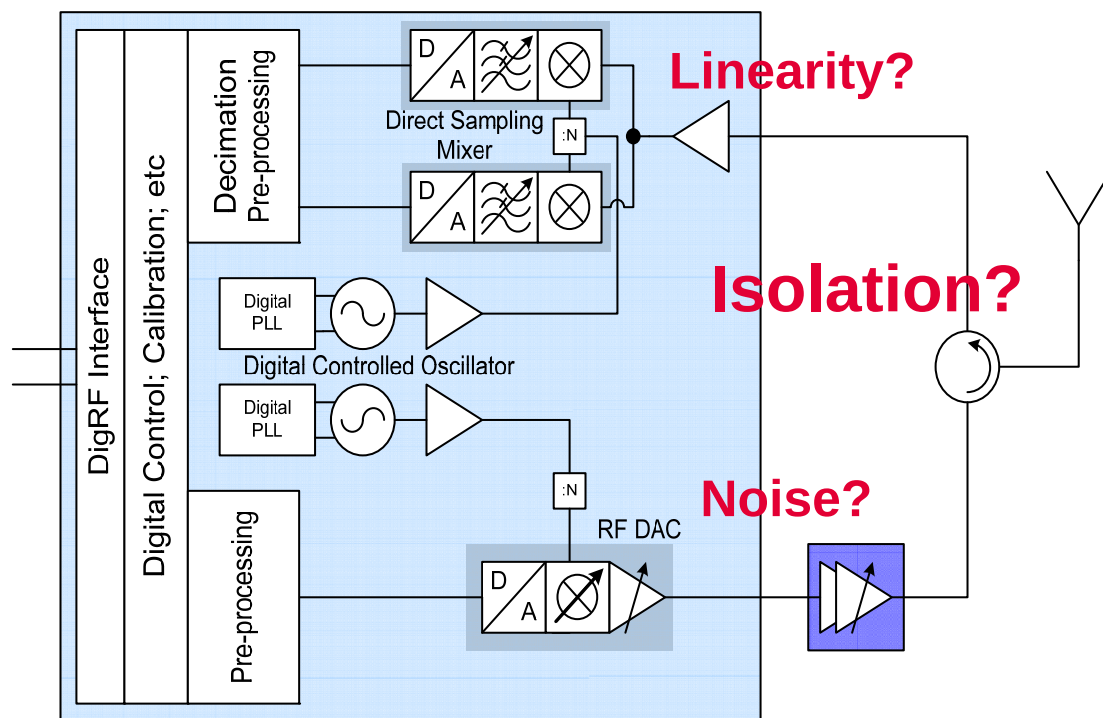
MPSoC 2008



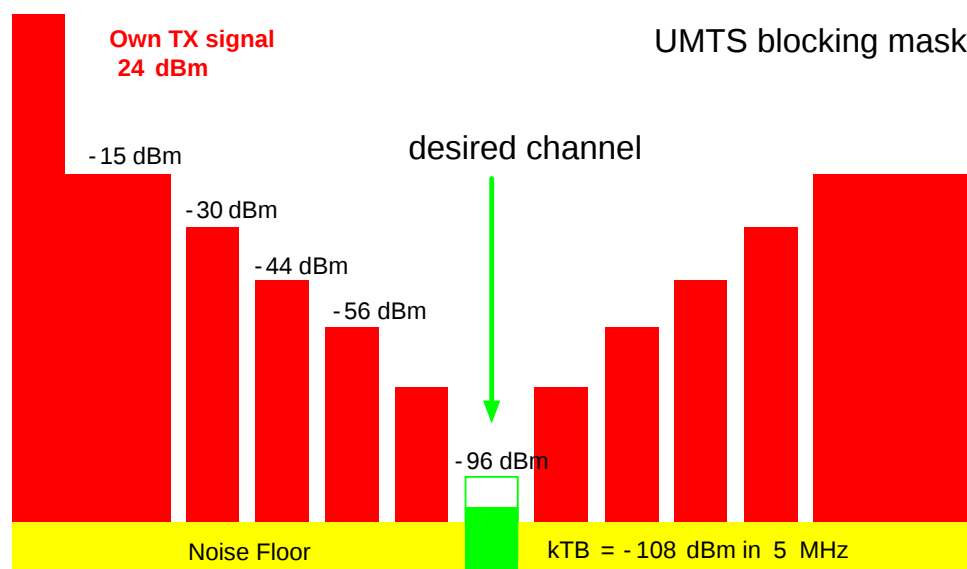
Outline

- Introduction
- Cellular RF SoC - State of the Art
- **Multistandard RF Requirements**
- Issues to solve
- Conclusions

RF Transceiver for Software Defined Radio?

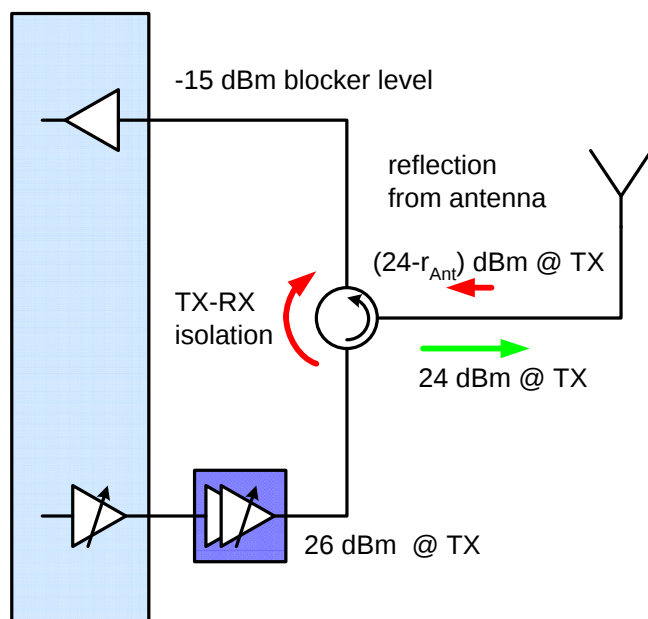


UMTS Interference - Blocking



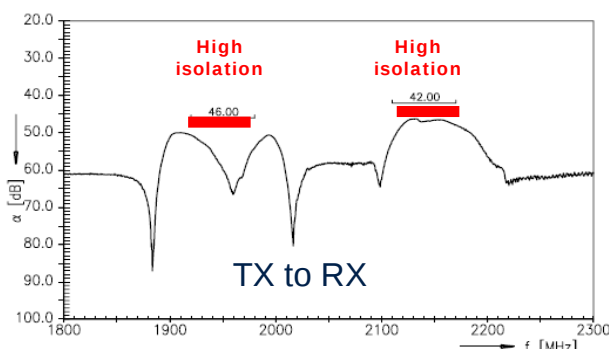
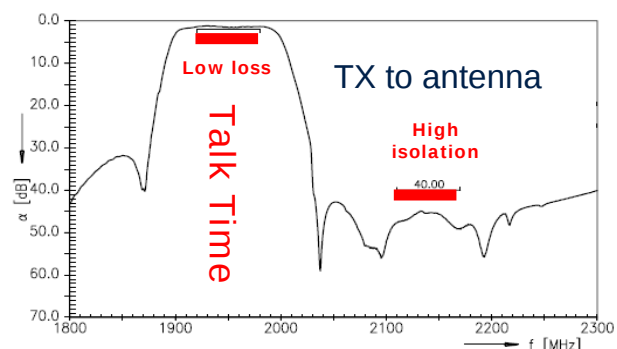
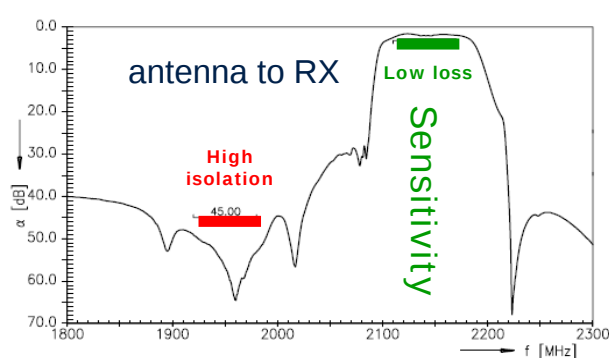
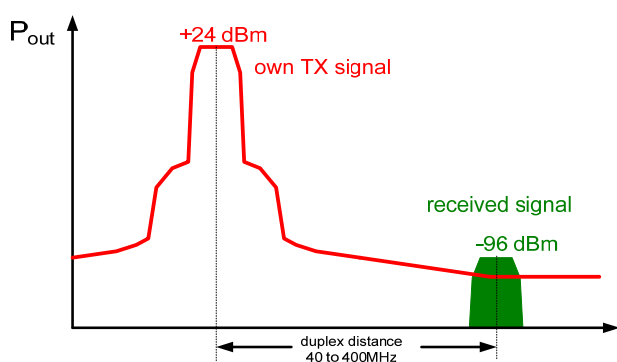
- 5th adjacent channel to be attenuated by about 90dB
- dynamic range distributed to analog filter and ADC
- TX signal is a real issue

UMTS – TX leakage in FDD Systems

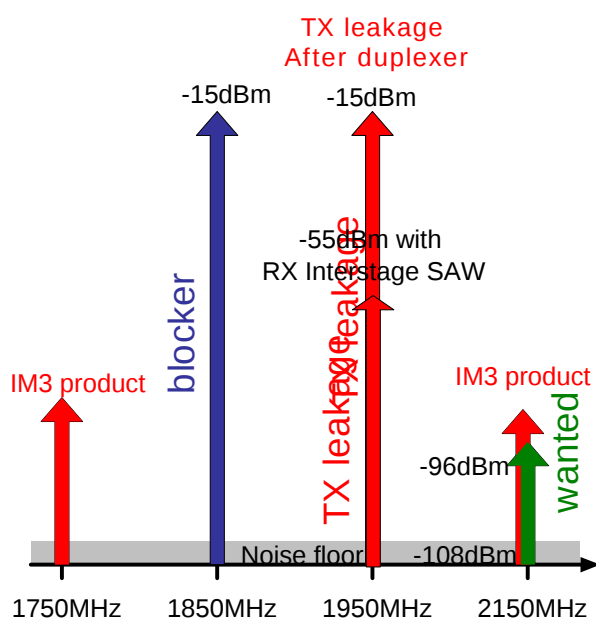


- Circulator has no selectivity
- RX-TX Isolation
 - At least 40dB
- Reflection from antenna
 - r_{Ant} above 40dB?
 - Antenna tuner?
- IP3 requirements?
 - Blocker and TX leakage are present at LNA

UMTS - FDD and Duplex Filter

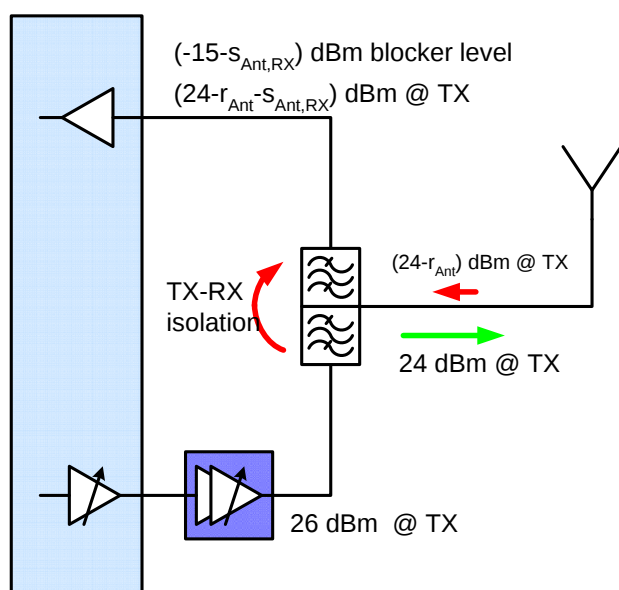


UMTS – IP3 & TX leakage in FDD Systems



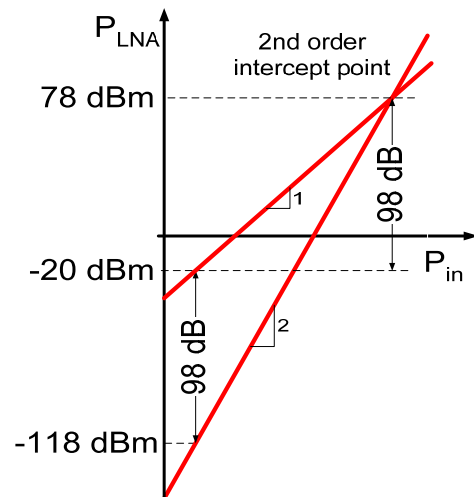
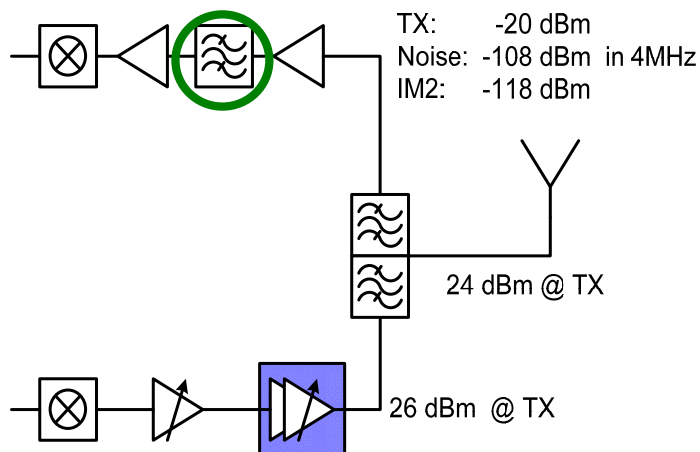
- Blocker and TX leakage are present at LNA
- IM3 product 10dB below noise floor
- IIP3 of 36dBm feasible?
- Circulator not feasible
- Duplex filter required!

UMTS – IP3 & TX leakage in FDD Systems



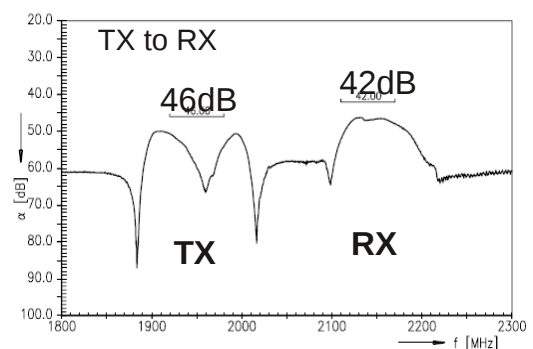
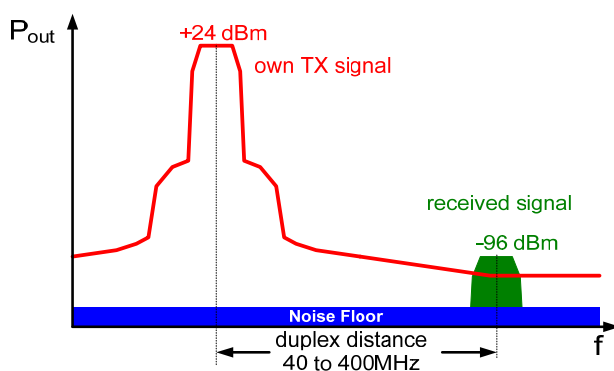
- Blocker and TX leakage are present at LNA
- IM3 product 10dB below noise floor
- IIP3 of 36dBm feasible?
- Circulator not feasible
- Duplex filter required!

UMTS - FDD requires RX Interstage Filter

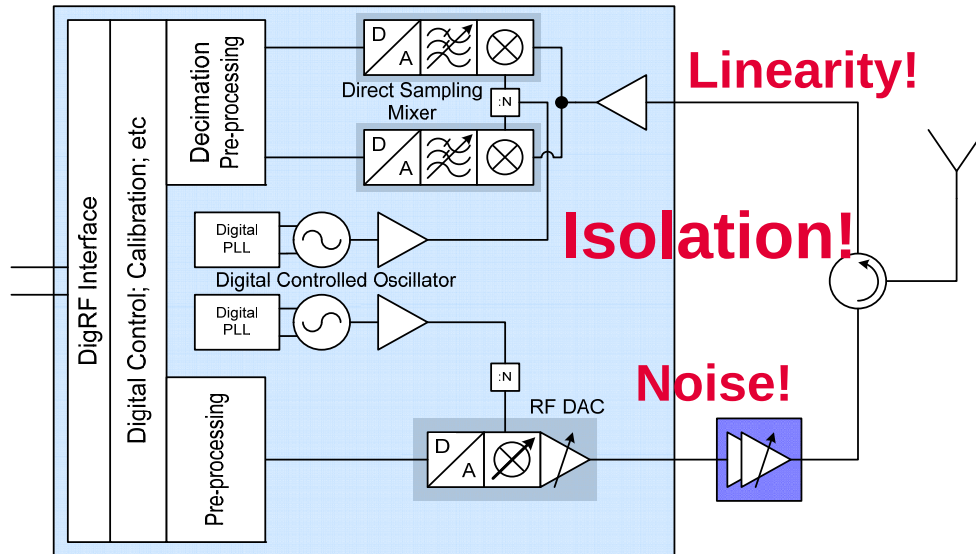


- 2nd order nonlinearity generates IM2 product at DC
- DC IM2 product has to 10dB below the noise floor referred to LNA
- RX interstage filter attenuates TX signal
- 1 dB attenuation reduces 2nd order intercept point by 2 dB

UMTS - TX Interstage Filter



- TX noise contribution at the RX input 6dB below thermal noise
 - -180 dBm/Hz equivalent to -204 dBc/Hz@24dBm output power
- -162dBc/Hz noise floor at duplex frequency
- Solutions
 - passive TX interstage filter
 - Higher duplexer isolation
 - reduce noise VCO and driver by increasing power and area

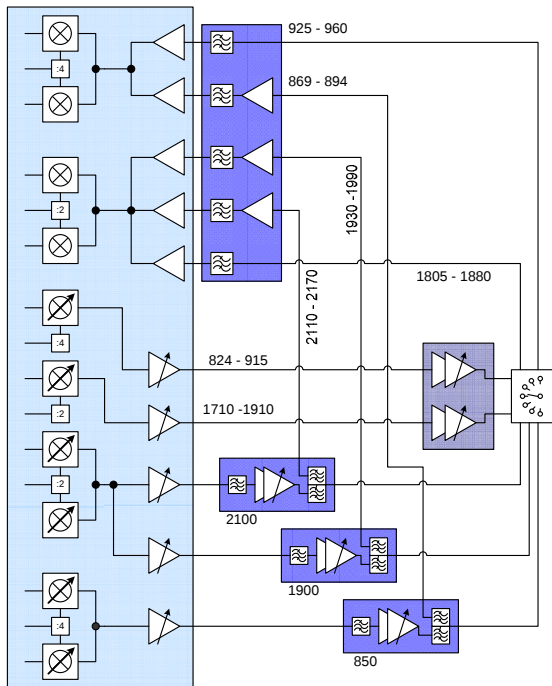


- TX leakage for FDD systems can not be handled.
- TX noise in RX band will limit sensitivity
- Blocker requirements for GSM can not be handled.

Outline

- Introduction
- Cellular RF SoC - State of the Art
- Multistandard RF Requirements
- **Issues to solve**
- Conclusions

UMTS/GSM Multistandard RF Frontend



- Wide-band front end not feasible
 - power
 - linearity
 - noise
- Duplex filter required
- TX interstage filter required
- Fixed passive filters
 - 3 UMTS front ends
 - 2 GSM front ends
 - switched to one antenna

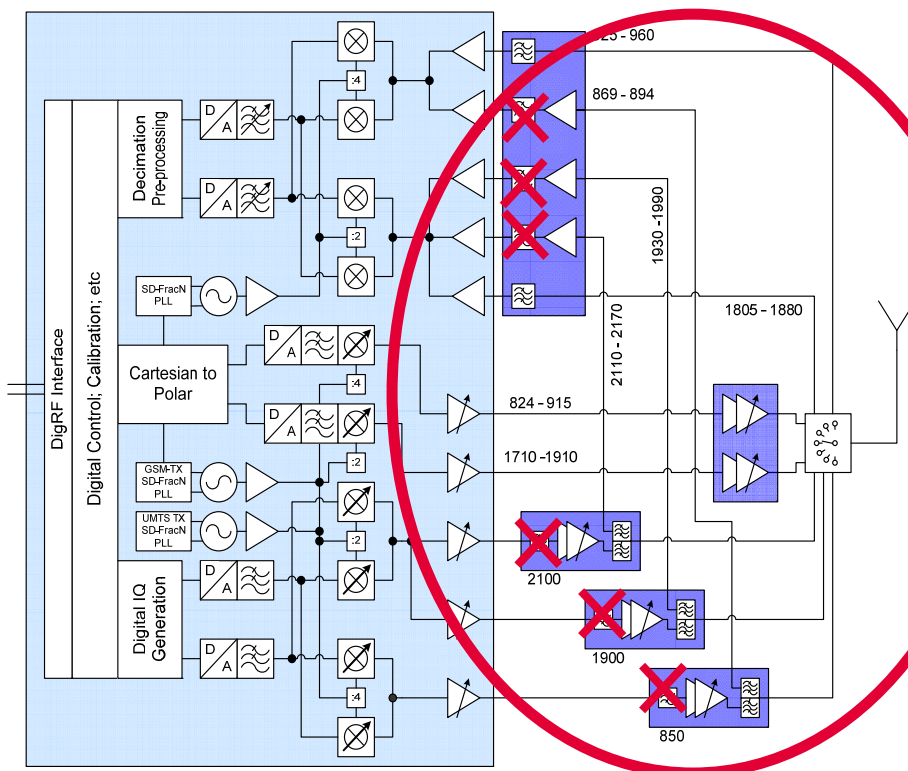
25. Juni 2008

MPSoC 2008



Page 21

The Real Challenge for Multistandard RF: Remove Interstage Filters



25. Juni 2008

MPSoC 2008



Page 22

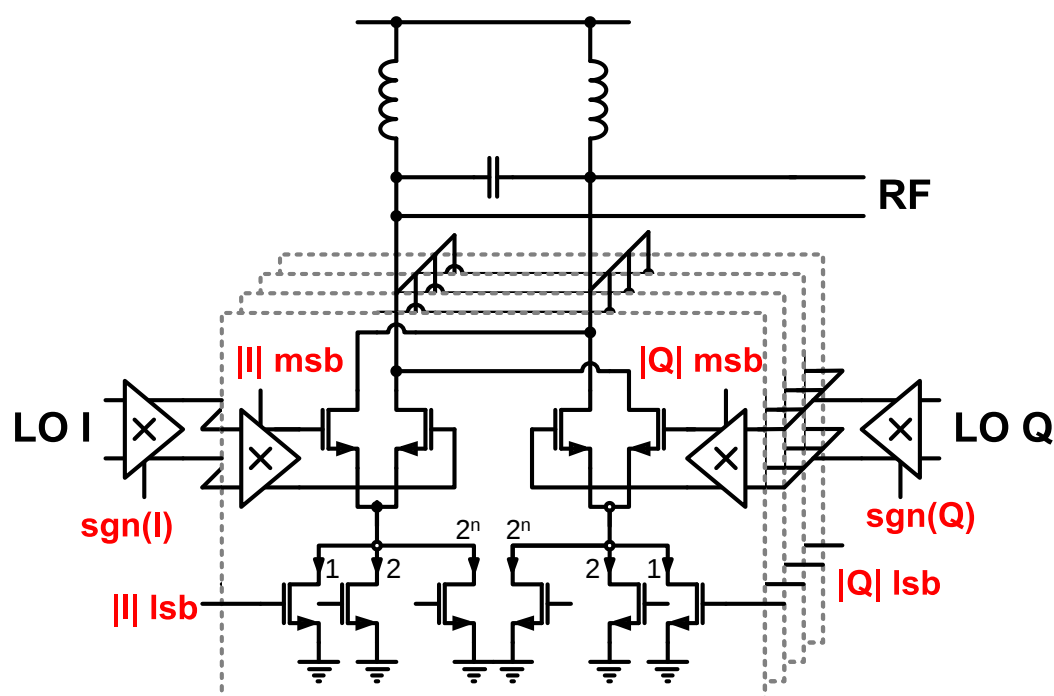
■ Remove external interstage filter

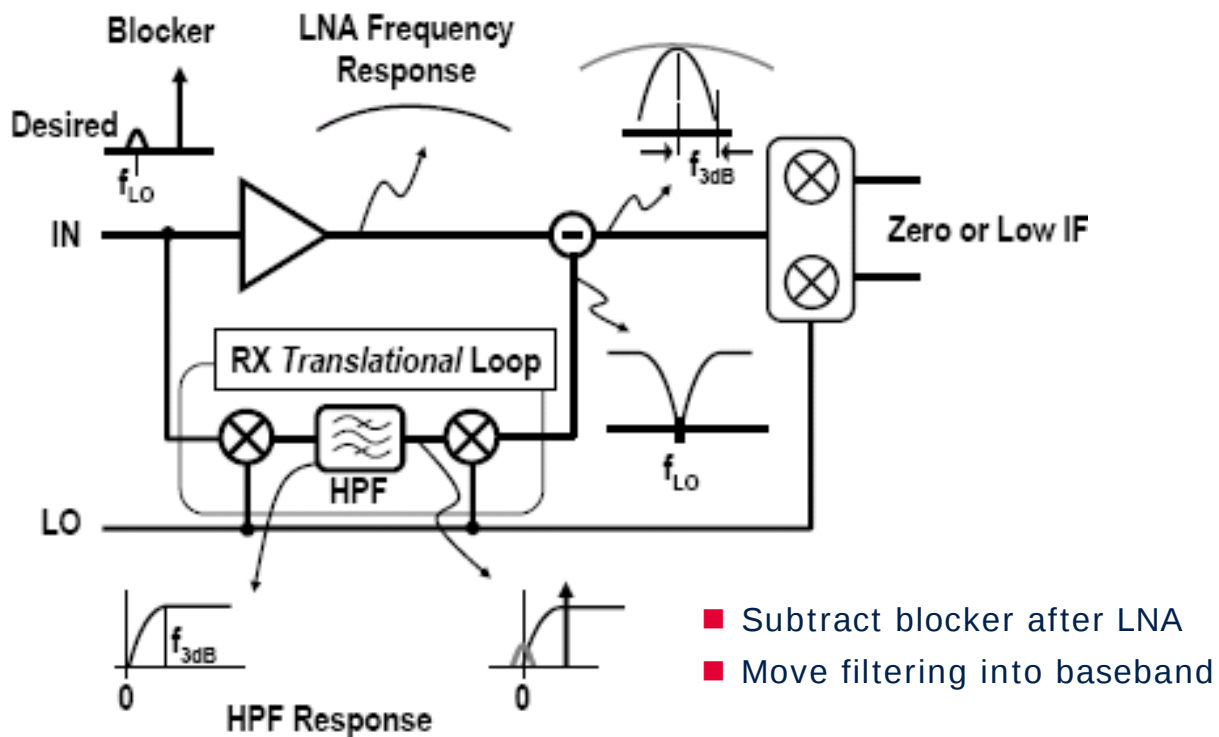
- high dynamic range transceiver frontend
- increase IP2 and IP3: filter, calibrate or cancel

■ Reconfigurable Circuitry

- reuse die area consuming blocks in different modes
- Reuse coils – switch between different frequency bands

IQ-RF DAC using fully switched Transistors





Challenges – Flexible RF Architectures

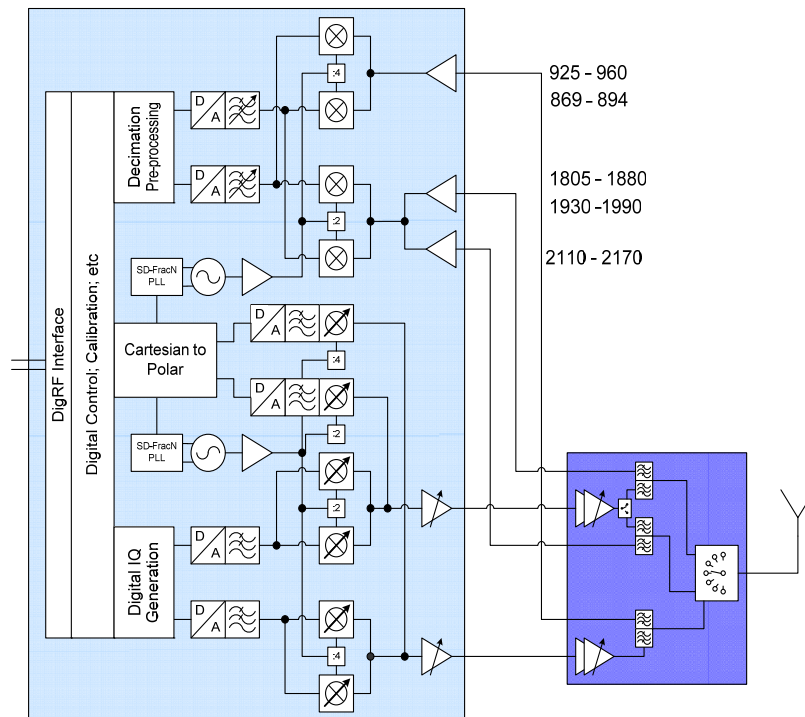
■ Remove external interstage filter

- high dynamic range receiver
- increase IP2 and IP3: filter, calibrate or cancel

■ Reconfigurable Circuitry

- reuse die area consuming blocks in different modes
- Reuse coils – switch between different frequency bands

Target: Multistandard RF Transceiver



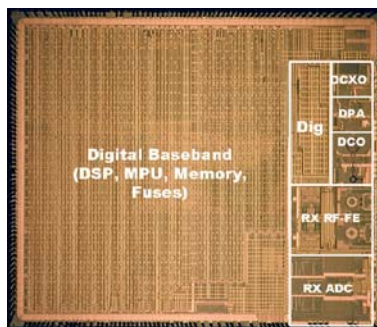
25. Juni 2008

MPSoC 2008

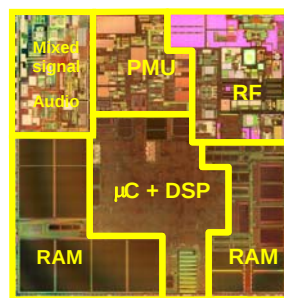


Page 27

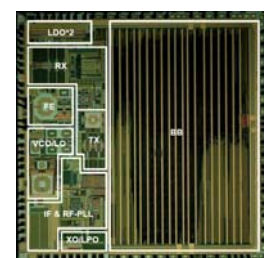
SoC Partition: Distribution of RF, Mixed-Signal, PMU, Digital, Memory



TI 90nm GSM SoC:
24mm²/3.8mm²
ISSCC 2008



IFX 130nm GSM SoC:
X mm²
ISSCC 2006



Broadcom 130nm
BT EDR SoC:
11.8mm²
ISSCC 2007

- Best Case: linear area reduction for Analog
- Real world application have only limited digital content
- Example: Smart Phone GSM/EDGE/UMTS
 - Start in 130nm
 - 70% digital; 25% analog&RF; 5% IO

25. Juni 2008

MPSoC 2008

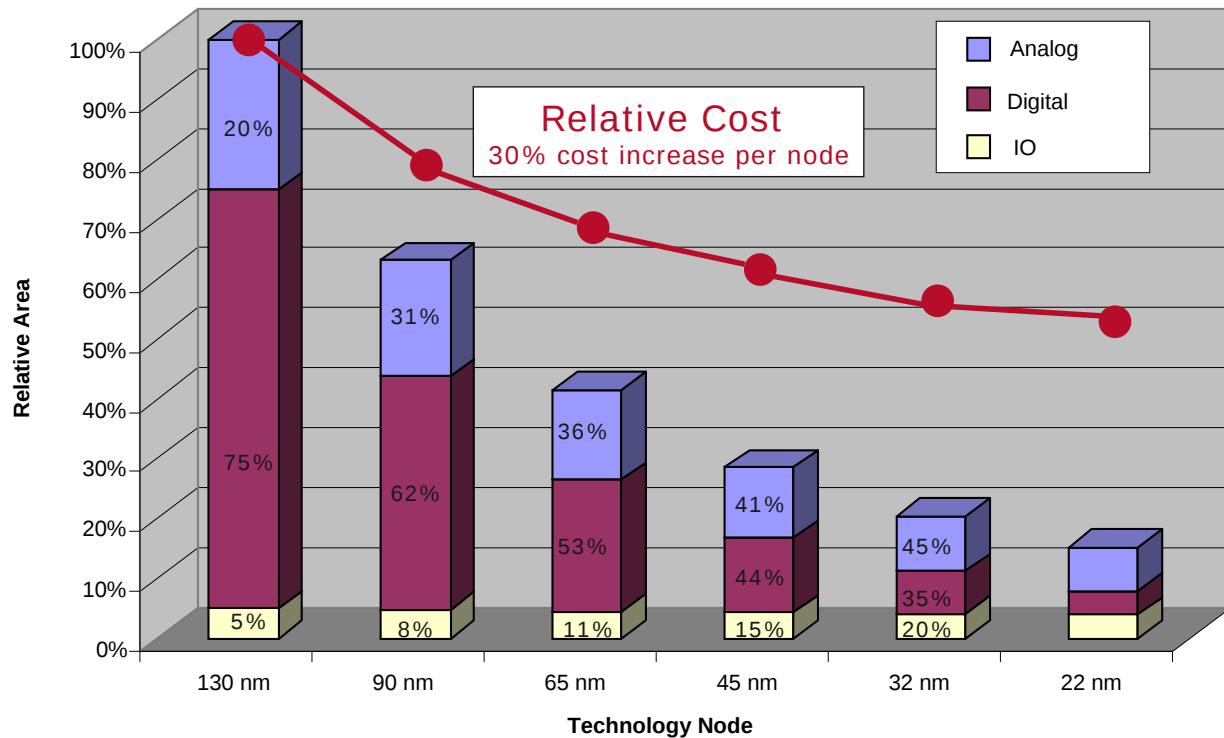


Page 28

Commercial Issues for RF SoC Integration



Die Shrink



25. Juni 2008

MPSoC 2008

RWTH AACHEN
UNIVERSITY

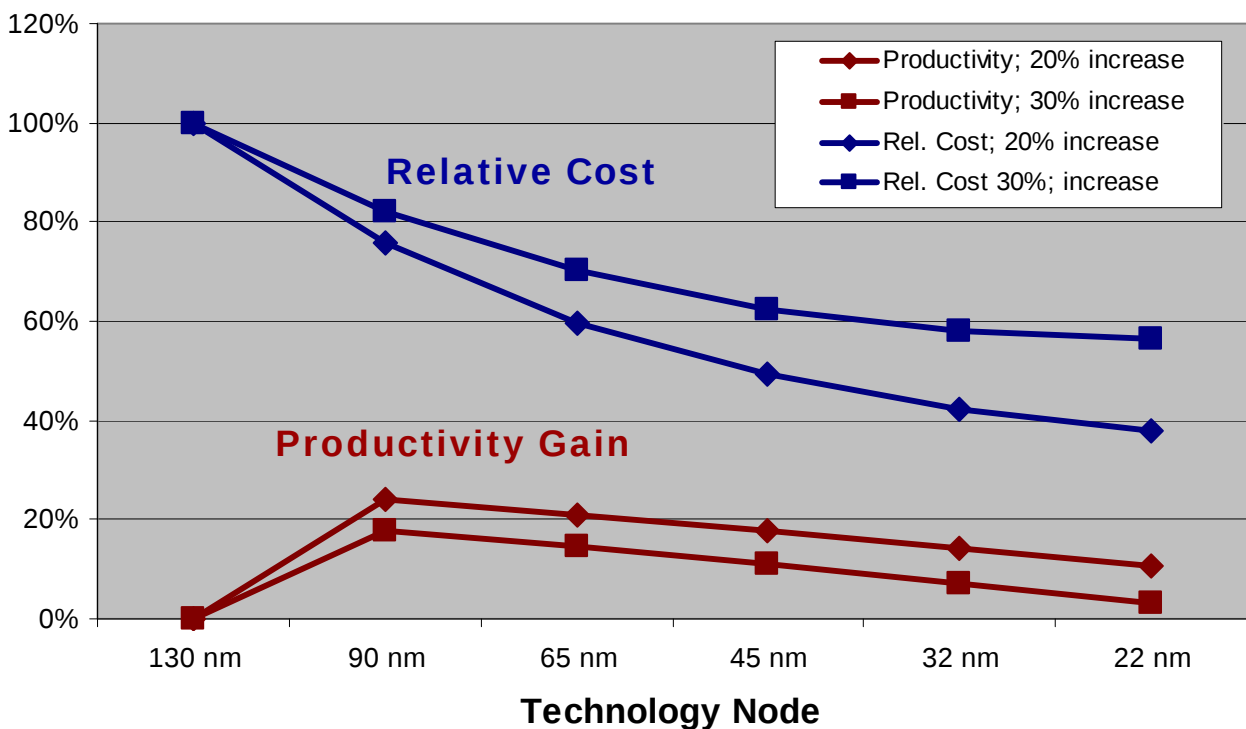
UMIC

Page 30

Productivity vers. Technology Node



Rel. vers CMOS Node



25. Juni 2008

MPSoC 2008

RWTH AACHEN
UNIVERSITY

UMIC

Page 31

- Introduction
- Cellular RF SoC - State of the Art
- Multistandard RF Requirements
- Issues to solve
- **Conclusions**

Conclusions – Challenges for Multistandard RF SoCs

- **High Dynamic Range**
 - Low supply voltage
 - High $1/f$ noise
- **Transistors are good high speed switches**
 - Use “fully switched” transistors
- **Replace RF / analog processing by digital techniques**
- **Complexity – Multi-standard RF SoC**
- **Commercial Feasibility**
 - Reuse RF blocks
 - Smart reconfigurable frequency agile RF transceiver
- **Spurs, Spurs, Spurs,**